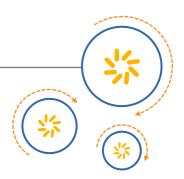


RF360 Europe GmbH A Qualcomm – TDK Joint Venture



SAW components

BAW filter WLAN 2G

Version:

Series/type:	B8863
Ordering code:	B39242B8863L210
Date:	March 30, 2017

2.0

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SAW components	B8863
BAW filter	2442 MHz

Data sheet

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SAW components	B8863
BAW filter	2442 MHz

Data sheet

Table of contents

1 Application	4
2 Features	4
3 Package	5
4 Pin configuration	5
5 Matching circuit	6
6 <u>Characteristics</u> .	7
7 Maximum ratings	8
8 Transmission coefficient	9
9 Reflection coefficients	
10 Packing material	
11 Marking	
12 <u>Soldering profile</u>	
13 Annotations	
14 Cautions and warnings	
Important notes	



2442 MHz

SAW components

BAW filter

Data sheet

1 Application

- Premium-performance low-loss BAW RF single filter for Bluetooth/WLAN with LTE Band 7 / Band 40 / Band 41 coexistence
- Usable pass band 79.0 MHz
- Unbalanced to unbalanced operation
- Filter impedance 50 Ω
- High out of band selectivity
- Excellent insertion loss

2 Features

- Package size 1.1 mm × 0.9 mm
- Package height 0.7 mm
- Approximate weight 1 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

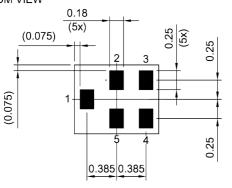
SAW components

BAW filter

Data sheet

3 Package

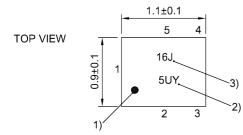
BOTTOM VIEW



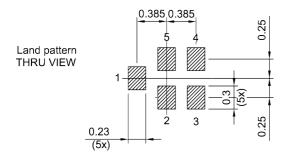
Pad and pitch tolerance ±0.05

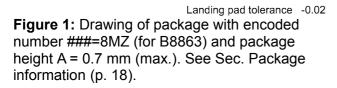
SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number





B8<u>863</u>

2442 MHz

4 Pin configuration

- 1 Input (to PA (unbalanced))
 - Output (to ANT (unbalanced))
- 2, 3, 5 Ground

4





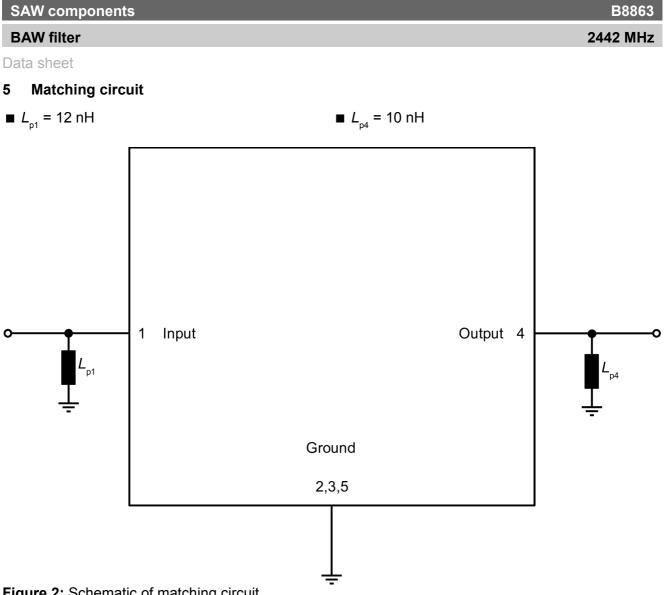


Figure 2: Schematic of matching circuit.

SAW components

BAW filter

Data sheet

6 Characteristics

Temperature range for specification
Input terminating impedance
Output terminating impedance

 $\begin{array}{ll} T_{\rm SPEC} & = -30 \ ^{\circ}{\rm C} \ ... \ +85 \ ^{\circ}{\rm C} \\ Z_{\rm IN} & = 50 \ \Omega \ {\rm with \ par.} \ 12 \ {\rm nH^{1}} \\ Z_{\rm OUT} & = 50 \ \Omega \ {\rm with \ par.} \ 10 \ {\rm nH^{1}} \end{array}$

Characteristics				min. for T _{SPEC}	typ. @ +25 °C	max. for T _{SPEC}	
Center frequency			f _c		2442		MHz
Maximum insertion attenuation			α _{max}				
Channel 1	2403.1 2420.9	MHz		—	1.6 ²⁾	2.4 ²⁾	dB
Channel 2	2408.1 2425.9	MHz		—	1.4 ²⁾	2.0 ²⁾	dB
Channel 3-10	2413.1 2465.9	MHz		_	1.3 ²⁾	1.8 ²⁾	dB
Channel 11	2453.1 2470.9	MHz		_	1.3 ²⁾	1.8 ²⁾	dB
Channel 12	2458.1 2475.9	MHz		_	1.4 ²⁾	2.0 ²⁾	dB
Channel 13	2463.1 2480.9	MHz		—	1.6 ²⁾	2.5 ²⁾	dB
Maximum VSWR			VSWR _{max}				
@ input port	2403.1 2420.9	MHz		—	1.3	2.3 ³⁾	
	2420.9 2480.9	MHz		—	1.5	2.3	
@ output port	2403.1 2420.9	MHz		—	1.3	2.3 ³⁾	
	2420.9 2480.9	MHz		—	1.6	2.3	
Minimum attenuation			$\alpha_{_{min}}$				
	100 1805	MHz		31	35	—	dB
	1805 2170	MHz		33	37	—	dB
	2300 2360	MHz		50 ⁴⁾	55 ⁴⁾	_	dB
	2360 2365	MHz		44 ⁴⁾	65 ⁴⁾	—	dB
	2365 2370	MHz		44 ⁴⁾	65 ⁴⁾	—	dB
	2370 2380	MHz		32 ⁴⁾	53 ⁴⁾	_	dB
	2496 2501	MHz		20 ^{3), 4)}	47 ⁴⁾	—	dB
	2500 2505	MHz		45 ^{3), 4)}	64 ⁴⁾	—	dB
	2505 2550	MHz		39 ⁴⁾	49 ⁴⁾	_	dB
	2550 2570	MHz		39 ⁴⁾	46 ⁴⁾	—	dB
	2570 2620	MHz		39 ⁴⁾	44 ⁴⁾	—	dB
	2620 2690	MHz		39 ⁴⁾	43 ⁴⁾	_	dB
	4800 5805	MHz		25	38	—	dB
	7200 7500	MHz		20	28	_	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Averaged value within each Wifi channel width of 17.8 MHz.

³⁾ +25°C to +85°C.

⁴⁾ Averaged values of linear S-parameter over any 5MHz.



B8863

2442 MHz



SAW components

BAW filter

B8863

2442 MHz

Data sheet

7 Maximum ratings

Storage temperature	$T_{\rm STG}^{2)}$ = -40 °C +85 °C ¹⁾	
DC voltage	$ V_{\rm DC} = 5.0 \rm V^{6)}$	
ESD voltage		
	$V_{\rm ESD}^{3)} = 50 \rm V$	Machine model.
	$V_{\rm ESD}^{4)} = 300 \rm V$	Human body model.
	$V_{\rm ESD}^{5)} = 600 \rm V$	Charged device model.
Input power	P _{IN}	
@ input port: 2403.1 2480.9 MHz	24 dBm	19 MHz WLAN signal for 5000 h @ 65 °C.
@ input port: other frequency ranges	5.0 dBm	Continuous wave for 5000 h @ 65 °C.

¹⁾ Extended upper limit: 96h@125°C acc. to IEC60068-2-2 Bb.

²⁾ Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

³⁾ According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

⁴⁾ According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

⁵⁾ According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

⁶⁾ 168h Damp Heat Steady State acc. to IEC60068-2-67 Cy.



2442 MHz

SAW components

BAW filter

Data sheet

8 Transmission coefficient

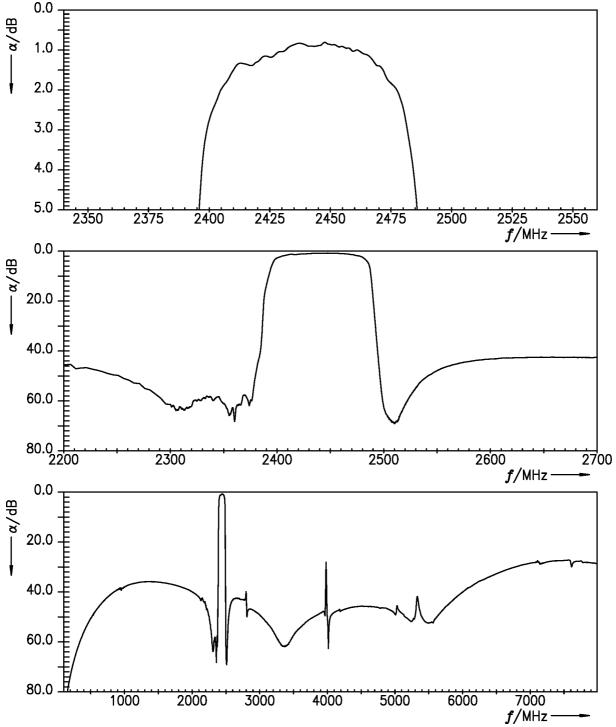


Figure 3: Attenuation.

SAW components

BAW filter

Data sheet

9

Reflection coefficients

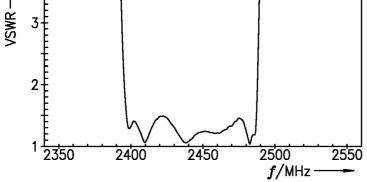
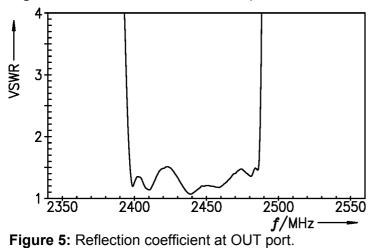
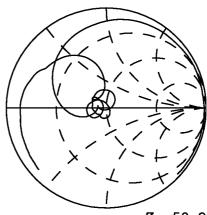


Figure 4: Reflection coefficient at IN port.

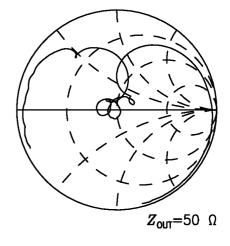






B8863

2442 MHz



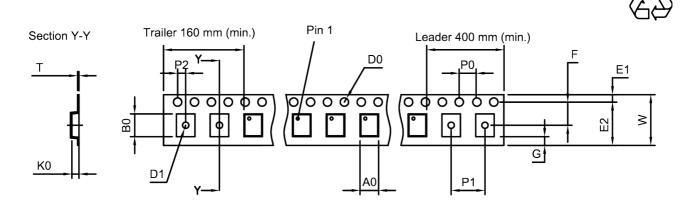
SAW components

BAW filter

Data sheet

10 Packing material

10.1 Tape



User direction of unreeling

Figure 6: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	1.1±0.05 mm
B ₀	1.3±0.05 mm
D ₀	1.5 mm
D ₁	0.4±0.05 mm
E1	1.75±0.1 mm

Table 1: Tape dimensions.

E2	-
F	3.5±0.05 mm
G	-
K ₀	0.76±0.03 mm
P ₀	4.0±0.1 mm

P ₁	2.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0±0.1 mm



2442 MHz



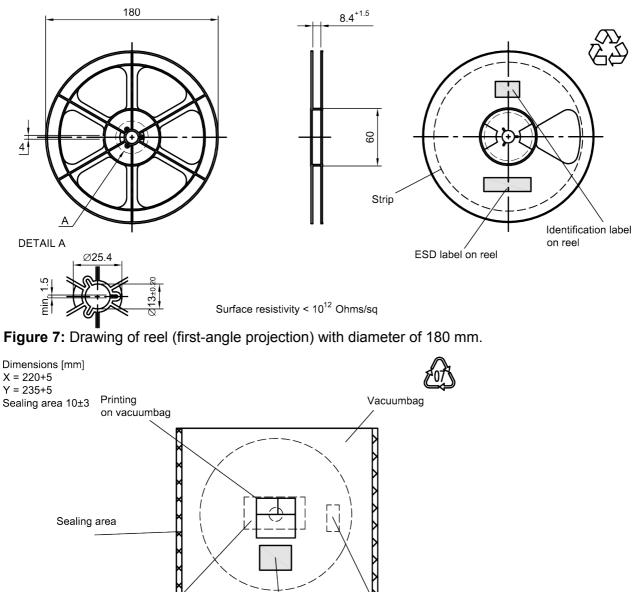
2442 MHz

SAW components

BAW filter

Data sheet

10.2 Reel with diameter of 180 mm



Drypack
in vacuumbagIdentification label
on vacuumbagHumidity indicator
in vaccumbagFigure 8: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

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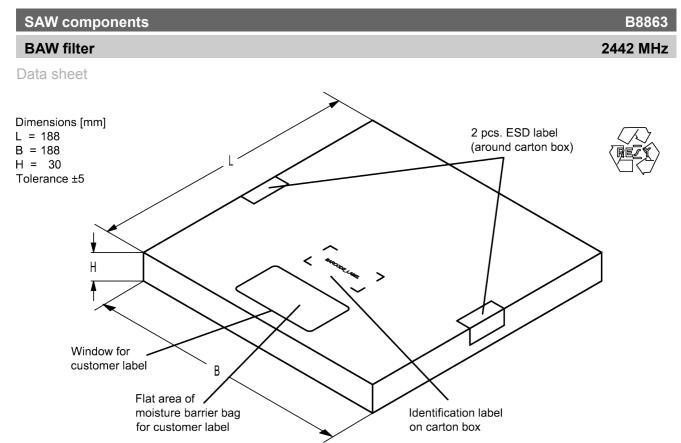
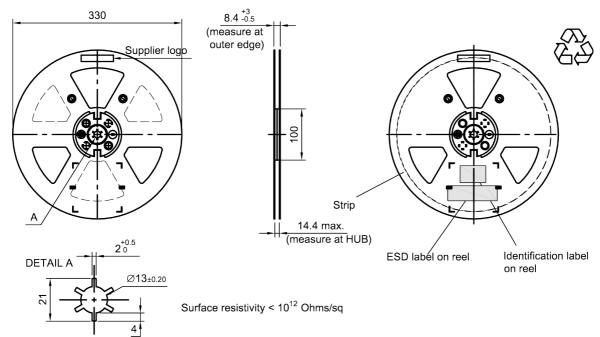
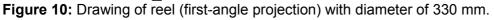


Figure 9: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm







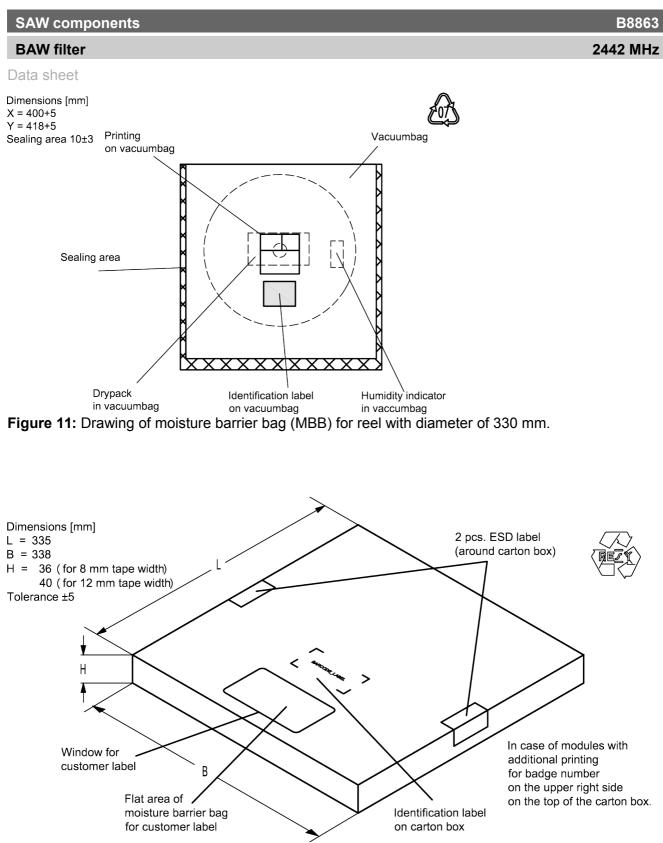


Figure 12: Drawing of folding box for reel with diameter of 330 mm.

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SAW components			B8863
BAW filter			2442 MHz
Data sheet			
11 Marking			
Products are marked with product type number and	lot number	encoded a	ccording to Table 2:
■ Type number:			
The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digi	t marking.	e.g., B3	xxxxB <u>1234</u> xxxx,
Example of decoding type number marking or 16J 1 x 32 ² + 6 x 32 ¹ + 18 (=J) x 32 ⁰ The BASE32 code for product type B8863 is 8MZ.	n device => =		in decimal code. 1234 1234
Lot number:			
The last 5 digits of the lot number, are encoded based on a special BASE47 code into	o a 3 digit m	e.g., narking.	12345,
Example of decoding lot number marking on device	е	in	decimal code.
5UY 5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=> =		12345 12345
Adopted BASE32 code for type number	Adopte	ed BASE47 o	ode for lot number
Desimal Resolution Resolution	Desimal	Dece 17	Desimal Bass 47

Adopted BASE32 code for type number				
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	K	
4	4	20	М	
5	5	21	N	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	A	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted BASE47 code for lot number				
Decimal	Base47	Decimal	Base47	
value	code	value	code	
0	0	24	R	
1	1	25	S	
2	2	26	Т	
3	3	27	U	
4	4	28	V	
5	5	29	W	
6	6	30	Х	
7	7	31	Y	
8	8	32	Z	
9	9	33	b	
10	A	34	d	
11	В	35	f	
12	С	36	h	
13	D	37	n	
14	E	38	r	
15	F	39	t	
16	G	40	v	
17	Н	41	١	
18	J	42	?	
19	K	43	{	
20	L	44	}	
21	М	45	<	
22	N	46	>	
23	Р			

Table 2: Lists for encoding and decoding of marking.



2442 MHz

SAW components

BAW filter

Data sheet

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3^{rd} edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s	
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s	
<i>T</i> > 220 °C	30 s to 70 s	
<i>T</i> > 230 °C	min. 10 s	
<i>T</i> > 245 °C	max. 20 s	
<i>T</i> ≥ 255 °C	-	
peak temperature T _{peak}	250 °C +0/-5 °C	
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s	
cooling rate	≤ 3 K/s	
soldering temperature T	measured at solder pads	

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

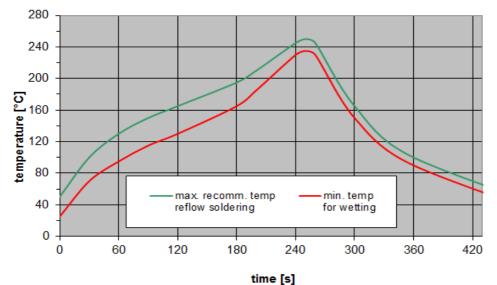


Figure 13: Recommended reflow profile for convection and infrared soldering – lead-free solder.



2442 MHz

SAW components	

BAW filter

Data sheet

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.4 Ordering codes and packing units

Ordering code	Packing unit
B39242B8863L210	15000 pcs
B39242B8863L210S 5	5000 pcs

 Table 4: Ordering codes and packing units.



2442 MHz

SAW components

BAW filter

Data sheet

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <u>www.rf360jv.com/orderingcodes</u>.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



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